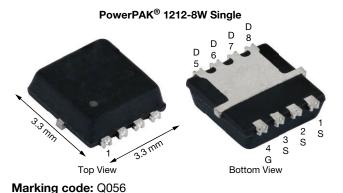
## SQS460CENW

www.vishay.com

Vishay Siliconix

## Automotive N-Channel 60 V (D-S) 175 °C MOSFET



# $\begin{tabular}{|c|c|c|c|} \hline PRODUCT SUMMARY \\ \hline V_{DS} (V) & 60 \\ \hline R_{DS(on)} (\Omega) \mbox{ at } V_{GS} = 10 \ V & 0.0300 \\ \hline R_{DS(on)} (\Omega) \mbox{ at } V_{GS} = 4.5 \ V & 0.0410 \\ \hline I_D (A) & 8 \\ \hline Configuration & Single \\ \hline Package & PowerPAK 1212-8W \\ \hline \end{tabular}$

#### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- AEC-Q101 qualified
- 100 %  $R_q$  and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



5				
Package	PowerPAK 1212-8W	N-Channel MOSFET		
ORDERING INFOR	MATION			
Package		PowerPAK 1212-8W		
Lead (Pb)-free and haloge	en-free	SQS460CENW		

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	60	V	
Gate-source voltage		V <sub>GS</sub>	V <sub>GS</sub> ± 20		
Continuous drain current <sup>a</sup>	T <sub>C</sub> = 25 °C	I	8	A	
Continuous drain current "	T <sub>C</sub> = 125 °C	I <sub>D</sub>	8		
Continuous source current (diode conduction	on) <sup>a</sup>	I <sub>S</sub>	8		
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	32	1	
Single pulse avalanche current L = 0.1 mH		I <sub>AS</sub>	13.5		
Single pulse avalanche energy		E <sub>AS</sub>	9.11	mJ	
Maximum newer dissipation	T <sub>C</sub> = 25 °C	P	27	14/	
Maximum power dissipation	T <sub>C</sub> = 125 °C	P <sub>D</sub>	9	W	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	0	
Soldering recommendations (peak temperat		260	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	81	°C/W		
Junction-to-case (drain)		R <sub>thJC</sub>	5.5	0/10		

#### Notes

a. Package limited

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

c. When mounted on 1" square PCB (FR4 material)

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK1212-8W package may have visible exposed Cu at the end of the lead terminals due to the singulation process. However, the leads also have plated indents on the top and bottom surfaces that promote the formation of a solder filet compatible with automated optical inspection methods.

e. Rework conditions: manual soldering with a soldering iron is not recommended

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SQS460CENW

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<b>SPECIFICATIONS</b> ( $T_C = 25 \text{ °C}$ , ur	SYMBOL	1		MIN.	TYP.	MAX.	UNIT
PARAMETER Static	STMBUL	TES	T CONDITIONS	MIN.	TTP.	WAX.	UNIT
	V	N N	0 1 050 0	60			
Drain-source breakdown voltage	V <sub>DS</sub>		$= 0, I_D = 250 \mu A$	60	-	-	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	-	$V_{GS}, I_D = 250 \mu A$	1.5	2.0	2.5	
Gate-source leakage	I <sub>GSS</sub>	+	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA
		$V_{GS} = 0 V$	$V_{DS}$ = 60 V, $T_{J}$ = 175 °C	-	-	150	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	20	-	-	A
		$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 5.3 A	-	0.0240	0.0300	Ω
Drain-source on-state resistance <sup>a</sup>	Provide	$V_{GS} = 10 V$	$I_D = 5.3 \text{ A}, \text{ T}_J = 125 \ ^\circ\text{C}$	-	-	0.0480	
Drain-source on-state resistance -	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 5.3 A, T <sub>J</sub> = 175 °C	-	-	0.0590	
		$V_{GS} = 4.5 V$	$I_D = 4 A$	-	0.0330	0.0410	
Forward transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> =	= 15 V, I <sub>D</sub> = 5.3 A	-	19	-	S
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>			-	493	580	
Output capacitance	Coss	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 25 V, f = 1 MHz	-	226	290	pF
Reverse transfer capacitance	C <sub>rss</sub>	_		-	13	20	
Total gate charge <sup>c</sup>	Qg			-	7.2	11	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V V <sub>DS</sub> = 30 V, I <sub>D</sub> = 4.5 A		-	2.15	-	nC
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	0.55	-	
Gate resistance	Rg		f = 1 MHz	0.63	1.27	1.90	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	9	14	
Rise time <sup>c</sup>	t <sub>r</sub>	- 	= 30 V, R <sub>L</sub> = 30 Ω	-	3	5	- ns
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 1 \text{ A}, \text{ V}$	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	16	24	
Fall time <sup>c</sup>	t <sub>f</sub>	-		-	15	23	
Source-Drain Diode Ratings and Charact							
Pulsed current <sup>a</sup>	I <sub>SM</sub>			_	-	32	А
Forward voltage	V <sub>SD</sub>		= 6 A, V <sub>GS</sub> = 0 V	_	0.845	1.1	V
Body diode reverse recovery time	vsD t <sub>rr</sub>			-	15	30	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	4			8	16	nC
Reverse recovery fall time		I <sub>F</sub> = 5 /	A, di/dt = 100 A/μs	-	0 9	10	
	t <sub>a</sub>	4		-	-	-	ns
Reverse recovery rise time	t <sub>b</sub>			-	6 -1	-	A

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

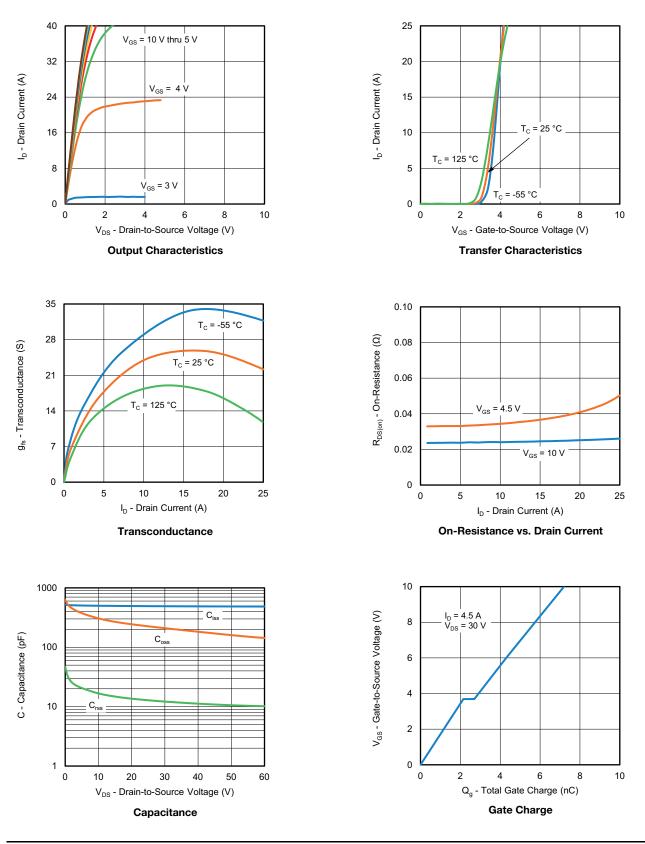
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



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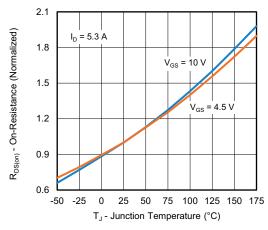
3

Document Number: 63156

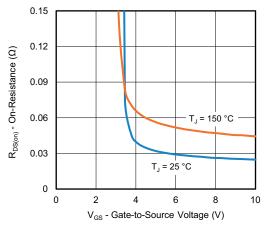
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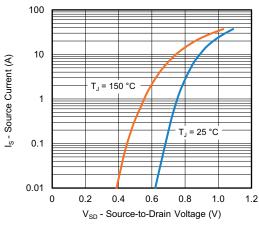
### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



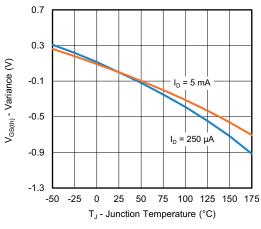
**On-Resistance vs. Junction Temperature** 



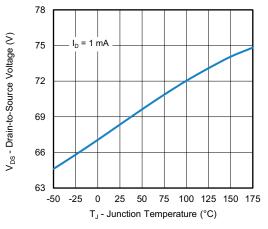
**On-Resistance vs. Gate-to-Source Voltage** 



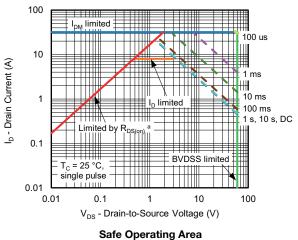
Source Drain Diode Forward Voltage

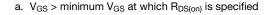


**Threshold Voltage** 



Drain Source Breakdown vs. Junction Temperature





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4 For technical questions, contact: automostech

Note

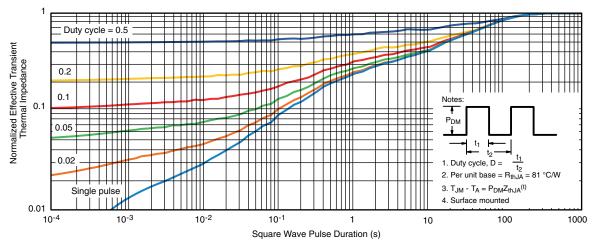
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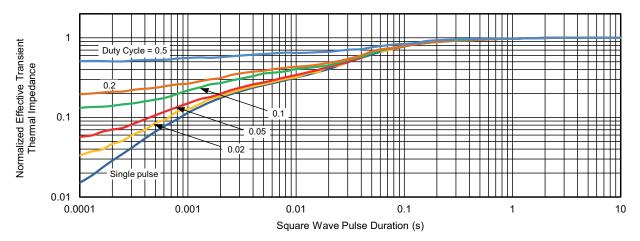


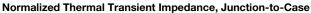


#### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient





#### Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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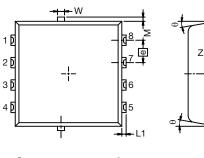
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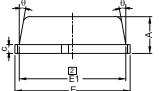


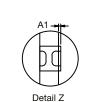
# PowerPAK<sup>®</sup> 1212-8W Case Outline

Δ2

224



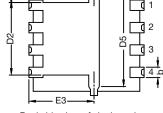




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Б



E2

E4

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Notes
1 Inch will govern

 Dimensions exclusive of mold gate burrs
 Dimensions exclusive of mold flash and cutting burrs

DIM.	MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.97	1.04	1.12	0.038	0.041	0.044
A1	0	-	0.05	0	-	0.002
A2	0	-	0.13	0	-	0.005
b	0.23	0.30	0.41	0.009	0.012	0.016
С	0.23	0.28	0.33	0.009	0.011	0.013
D	3.20	3.30	3.40	0.126	0.130	0.134
D1	2.95	3.05	3.15	0.116	0.120	0.124
D2	1.98	2.11	2.24	0.078	0.083	0.088
D4	0.47 typ.			0.0185 typ.		
D5	2.3 typ.			0.090 typ.		
E	3.20	3.30	3.40	0.126	0.130	0.134
E1	2.95	3.05	3.15	0.116	0.120	0.124
E2	1.47	1.60	1.73	0.058	0.063	0.068
E3	1.75	1.85	1.98	0.069	0.073	0.078
E4		0.34 typ.			0.013 typ.	
е		0.65 BSC.		0.026 BSC		
К		0.86 typ.		0.034 typ.		
Н	0.30	0.41	0.51	0.012	0.016	0.020
L	0.30	0.43	0.56	0.012	0.017	0.022
L1	0.06	0.13	0.20	0.002	0.005	0.008
θ	0°	-	12°	0°	-	12°
W	0.15	0.25	0.36	0.006	0.010	0.014
М	0.125 typ.			0.005 typ.		
N: C15-1530-R	ev. B, 16-Nov-15					

Backside view of single pad



## RECOMMENDED MINIMUM PADS FOR PowerPAK<sup>®</sup> 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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